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Tak Chi SHER					Name: Address	Wah Ha Industrial Building 8 Shipyard Lane Quarry Bay	
Additi	ional name	e(s) of conv	eying party	(ies) attached? ☐ Yes ⊠ No	Country	: Hong Kong	
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	Name and address of party to whom correspondence concerning document should be mailed:				6. Numb	er of applications and patents invo	olved: <u>1</u>
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PATENT REEL: 015266 FRAME: 0352

ASSIGNMENT

WHEREAS, I, SHER Tak Chi, ASSIGNOR, a citizen of Hong Kong, residing at Flat D, 19th Floor, Wah Ha Industrial Building, 8 Shipyard Lane, Quarry Bay, Hong Kong, am the inventor of the invention entitled Portion of Lighter , for which I have executed an application for a patent of the United States of even date herewith; and

WHEREAS, **POLYCITY ENTERPRISE LIMITED**, a Hong Kong company, ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the same invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the said ASSIGNOR in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models and design which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner of Patents of the United States, and any official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisions, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this <u>18</u> day of <u>April</u> 2004.

SHER Tak Chi

Inventor